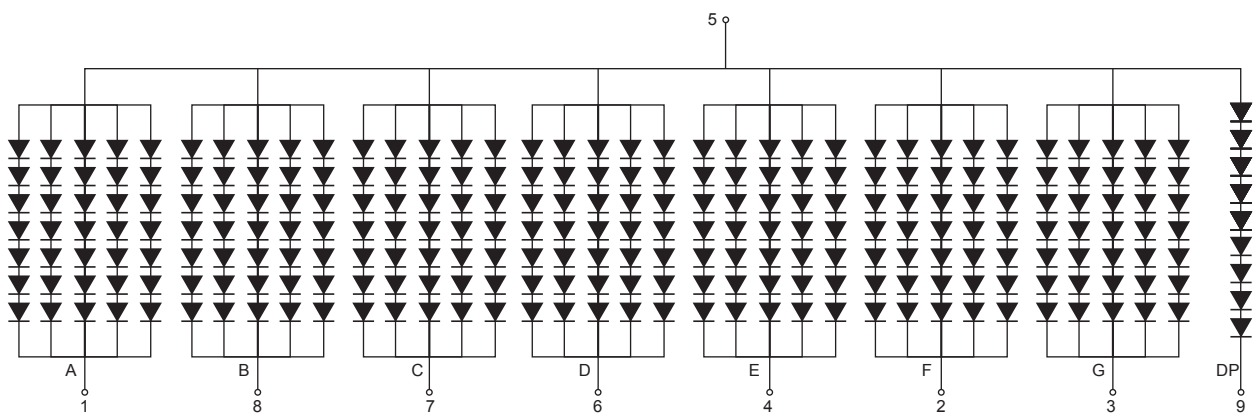
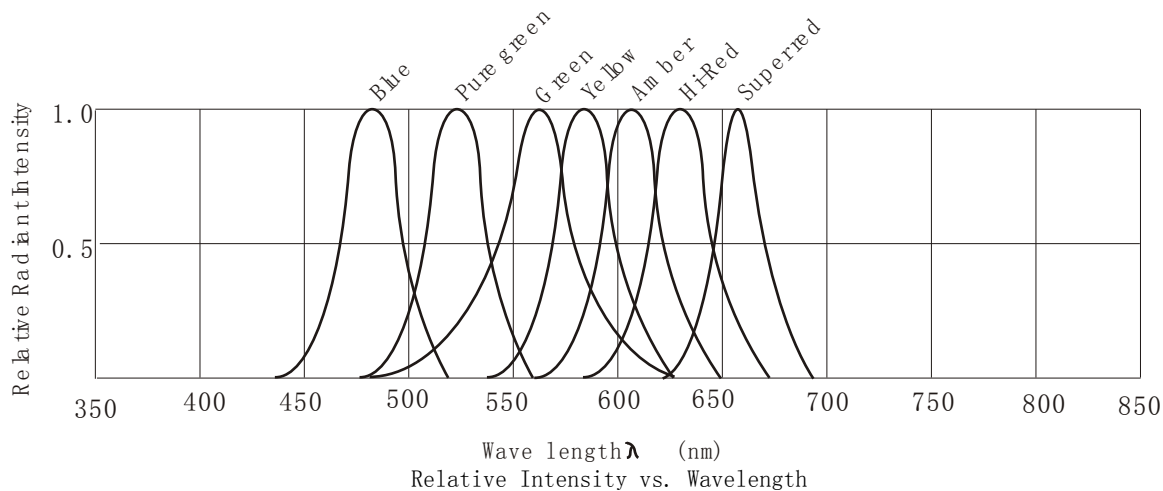






SEGMENT

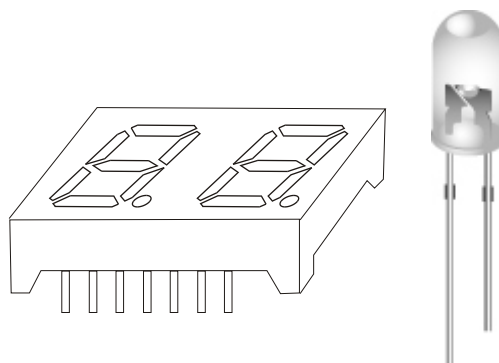
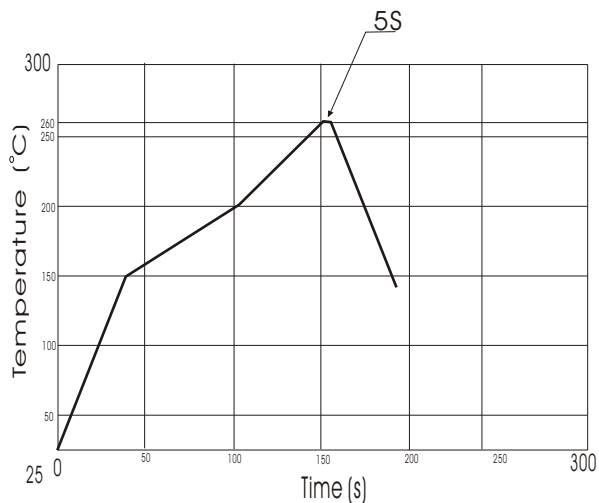
Parameter	Symbol	Condition	Min.	Typ .	Max.	Unit
Forward Voltage	Vf	If=360mA	13.8		14.2	V
Reverse Voltage	Vr	Ir=10uA	5.0			V
Luminous Intensty	Iv	If=360mA	1.57			cd
Spectrum With Of Half Value	$\Delta\lambda$	If=360mA	22			nm
Wavelength	D λ	If=360mA	585	587	589	nm
Operating Temperature Range		-35℃ to 85℃				
Storage Temperature Range		-35℃ to 85℃				
Solder Temperature 1.5mm below seating plane for 3 Seconds at 260℃						

DOT

Parameter	Symbol	Condition	Min.	Typ .	Max.	Unit
Forward Voltage	Vf	If=80mA	17.8		18.2	V
Reverse Voltage	Vr	Ir=10uA	5.0			V
Luminous Intensty	Iv	If=80mA	1.57			cd
Spectrum With Of Half Value	$\Delta\lambda$	If=80mA	22			nm
Wavelength	D λ	If=80mA	585	587	589	nm
Operating Temperature Range		-35 C to 85°C				
Storage Temperature Range		-35°C to 85°C				
Solder Temperature 1.5mm below seating plane for 3 Seconds at 260°C						

Absolute Maximum Rating at Ta=25°C

Wave Soldering for Lead-Free Through-hole LED

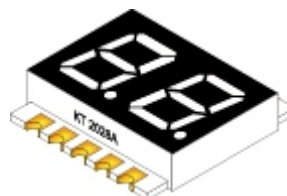
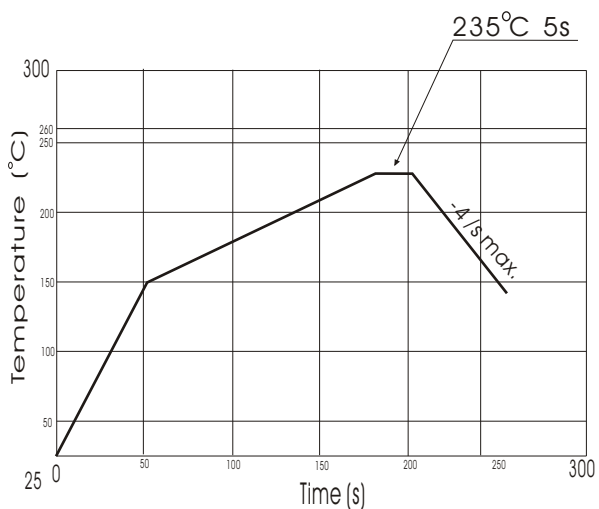


1.5mm below package base

Solder Temperature

260°C for 3 Seconds

Lead-free SMT process



Lead solder Temperature

235°C for 5 Seconds

Notes: Recommend the wave temperature max. 235°C.
Do not apply stress on the epoxy when temperature over 80°C.
No more than once.